

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT5955911

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ZHEBO CHEN	12/11/2017
NIALL DONNELLY	09/26/2017
TIM HOLME	07/25/2017
DEEPIKA SINGH	07/25/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	QUANTUMSCAPE CORPORATION
<b>Street Address:</b>	1730 TECHNOLOGY DRIVE
<b>City:</b>	SAN JOSE
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	95110
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16786837
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(415)393-9887
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	(415)9540200
<b>Email:</b>	sfripdocket@squirepb.com
<b>Correspondent Name:</b>	SQUIRE PATTON BOGGS (US) LLP
<b>Address Line 1:</b>	275 BATTERY STREET, SUITE 2600
<b>Address Line 4:</b>	SAN FRANCISCO, CALIFORNIA 94111
<b>ATTORNEY DOCKET NUMBER:</b>	114826.00400
<b>NAME OF SUBMITTER:</b>	TODD OSTOMEL
<b>SIGNATURE:</b>	/ToddOstomelReg63426/
<b>DATE SIGNED:</b>	02/10/2020
<b>Total Attachments: 4</b>	
source=114826_00400 Assignments#page1.tif	
source=114826_00400 Assignments#page2.tif	
source=114826_00400 Assignments#page3.tif	



ASSIGNMENT

WHEREAS, I, Zhebo CHEN, ASSIGNOR, citizen of the United States of America, with a mailing address at c/o QuantumScape Corporation, 1730 Technology Drive, San Jose, California, 95110, in relation to the invention for which an application for patent has been filed on May 15, 2017 as U.S. Application No. 15/595,755 (Docket No. 114826.00257), entitled **SOLID ELECTROLYTE SEPARATOR BONDING AGENT**,

and WHEREAS, QuantumScape Corporation, a corporation organized and existing under the laws of the state of Delaware, and having an office for the transaction of business at 1730 Technology Drive, San Jose, California, 95110, herein referred to as "ASSIGNEE," is desirous of obtaining my entire right, title and interest in, to and under the said invention and the said application.

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the said invention, and the said application and all applications claiming priority thereto and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

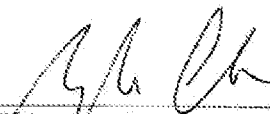
AND I HEREBY authorize and request the Commissioner for Patents and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

AND I HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;

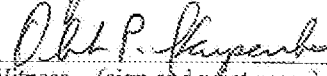
AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year set opposite my respective signature.

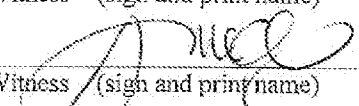
Date 12/11/17

  
\_\_\_\_\_  
Zhebo CHEN L.S.

Date 12/11/2017

  
\_\_\_\_\_  
Witness (sign and print name) OLEG P. KARPENKO

Date 12/13/2017

  
\_\_\_\_\_  
Witness (sign and print name) ANNIE CHAI

**ASSIGNMENT**

WHEREAS, I, Niall DONNELLY, ASSIGNOR, citizen of the United Kingdom, with a mailing address at c/o QuantumScape Corporation, 1730 Technology Drive, San Jose, California, 95110, in relation to the invention for which an application for patent has been filed on May 15, 2017 as U.S. Application No. 15/595,755 (Docket No. 114826.00257), entitled **SOLID ELECTROLYTE SEPARATOR BONDING AGENT**,

and WHEREAS, QuantumScape Corporation, a corporation organized and existing under the laws of the state of Delaware, and having an office for the transaction of business at 1730 Technology Drive, San Jose, California, 95110, herein referred to as "ASSIGNEE," is desirous of obtaining my entire right, title and interest in, to and under the said invention and the said application.

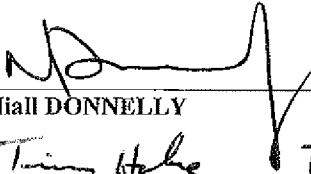
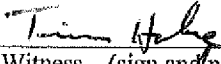
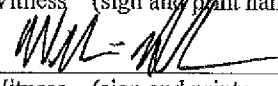
NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the said invention, and the said application and all applications claiming priority thereto and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

AND I HEREBY authorize and request the Commissioner for Patents and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

AND I HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;

AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year set opposite my respective signature.

Date	<u>9/26/17</u>		L.S.
		Niall DONNELLY	
Date	<u>9-26-17</u>		
		Tim Holme	
		Witness (sign and print name)	
Date	<u>9/26/17</u>		
		Witness (sign and print name)	

**ASSIGNMENT**

WHEREAS, I, **Tim HOLME**, ASSIGNOR, citizen of the United States of America, with a mailing address at c/o QuantumScape Corporation, 1730 Technology Drive, San Jose, California, 95110, in relation to the invention for which an application for patent has been filed on **May 15, 2017** as U.S. Application No. **15/595,755** (Docket No. 114826.00257), entitled **SOLID ELECTROLYTE SEPARATOR BONDING AGENT**,

and WHEREAS, **QuantumScape Corporation**, a corporation organized and existing under the laws of the state of Delaware, and having an office for the transaction of business at 1730 Technology Drive, San Jose, California, 95110, herein referred to as "ASSIGNEE," is desirous of obtaining my entire right, title and interest in, to and under the said invention and the said application.

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the said invention, and the said application and all applications claiming priority thereto and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

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AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year set opposite my respective signature.

Date 7-25-17

Tim Holme L.S.  
Tim HOLME

Date 7-25-17

Chris Eakins Chris Eakins  
Witness (sign and print name)

Date 7-25-17

Paul M...  
Witness (sign and print name)

### ASSIGNMENT

WHEREAS, I, **Deepika SINGH**, ASSIGNOR, citizen of India, with a mailing address at c/o QuantumScape Corporation, 1730 Technology Drive, San Jose, California, 95110, in relation to the invention for which an application for patent has been filed on **May 15, 2017** as U.S. Application No. **15/595,755** (Docket No. 114826.00257), entitled **SOLID ELECTROLYTE SEPARATOR BONDING AGENT**,

and WHEREAS, **QuantumScape Corporation**, a corporation organized and existing under the laws of the state of Delaware, and having an office for the transaction of business at 1730 Technology Drive, San Jose, California, 95110, herein referred to as "ASSIGNEE," is desirous of obtaining my entire right, title and interest in, to and under the said invention and the said application.

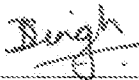
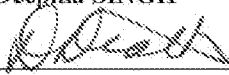
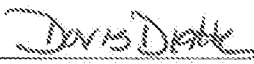
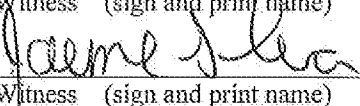
NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the said invention, and the said application and all applications claiming priority thereto and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

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IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year set opposite my respective signature.

Date <u>07/25/17</u>	 _____ <b>Deepika SINGH</b>	L.S.
Date <u>7/25/17</u>	 _____ Witness (sign and print name)	 _____ Witness (sign and print name)
Date <u>7/25/17</u>	 _____ Witness (sign and print name)	